

IN THE CLAIMS:

1-40. (Canceled)

41. (Currently Amended) A method of manufacturing laminated capacitors, said method comprising the steps of:

forming one of dielectrics made of organic polymer, and composite dielectrics made of organic high polymer and oxide of a metal ~~constituting said~~ comprising a conductor;

forming an insulating layer at least on conductor;

forming an opposite electrode on said dielectrics to complete a capacitor element;

laminating together a plurality of said capacitor elements;
and

forming an external connection terminal.

42. (Previously Presented) The method of manufacturing the laminated capacitors as defined in Claim 41, wherein said dielectrics is formed by electro-depositing organic polymer.

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43. (Currently Amended) The method of manufacturing laminated capacitors as defined in Claim 41, wherein said compound dielectrics is formed by ~~simultaneous progression of:~~

~~electrodeposition of~~ simultaneously electrodepositing organic polymer~~+~~ and

~~anodization of~~ anodizing a metal constituting comprising said conductor.

44. (Currently Amended) The method of manufacturing laminated capacitors as defined in Claim 41, wherein said opposite electrode is formed using ~~one of:~~ by

07 chemical oxy-polymerization~~+~~ and or

both chemical oxy-polymerization and electro-polymerization.

45. (Currently Amended) The method of manufacturing laminated capacitors as defined in Claim 41, wherein said opposite electrodes of said adjacent capacitor elements are bonded using conductive adhesive ~~in said step of~~ during laminating a plurality of said capacitor elements.

46. (Previously Presented) The method of manufacturing laminated capacitors as defined in Claim 41, wherein pressure is applied during bonding using said conductive adhesive.

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47. (Currently Amended) The method of manufacturing laminated capacitors as defined in claim 42, wherein said organic polymer is ~~a polyamide~~ selected from the group consisting of electro-deposited polyamide and electro-deposited polycarboxylic acid resin.

D3 48. (New) The method of manufacturing laminated capacitor as defined in Claim 47, wherein said polyimide is a reaction product of an aromatic tetracarboxylic acid di-anhydride and an aromatic diamine having at least one carboxylic acid radical.

49. (New) The method of manufacturing laminated capacitor as defined in Claim 47, wherein said polycarboxylic acid resin has at least one carboxylic acid radical in its chemical structure.

50. (New) The method of manufacturing laminated capacitor as defined in Claim 47, wherein said polycarboxylic acid resin is a polyacrylic acid-derived resin.

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51. (New) The method of manufacturing laminated capacitor as defined in Claim 41, wherein at least a part of said opposite electrode is made of conductive polymer.

52. (New) The method of manufacturing laminated capacitor as defined in Claim 51, wherein said conductive polymer is selected from the group consisting of polypyrrole, polythiophene, and derivatives thereof.

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53. (New) The method of manufacturing laminated capacitor as defined in Claim 51, wherein said conductive polymer is formed by chemical oxy-polymerization or chemical oxy-polymerization and electro-polymerization.

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54. (New) The method of manufacturing laminated capacitor as defined in Claim 41, wherein one of said conductor and said opposite electrode is one of a metal foil and a metal layer formed on a substrate.

55. (New) The method of manufacturing laminated capacitors as defined in Claim 54, wherein said metal layer is formed by either vacuum process or plating.

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